1. General description

The NX5DV715 is a dual supply 1-to-2 VGA switch. It integrates high-bandwidth SPDT switches with level-translating buffers and level translating switches to provide switching of input RGB, H-Sync, V-Sync and DDC signals to either of two output channels.

The NX5DV715 is characterized for operation from –40 °C to +85 °C.

2. Features and benefits

- RGB switches:
 - Low ON resistance (4 Ω typical)
 - Low ON capacitance (12 pF typical)
 - Low output skew (50 ps)
- Low power consumption (< 2 μA)</p>
- Level translation of sync and DDC signals
- Over-voltage tolerant inputs
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 4 kV
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101D exceeds 1000 V
 - IEC61000-4-2 contact discharge exceeds 4 kV for I/Os
- Specified from –40 °C to +85 °C

3. Applications

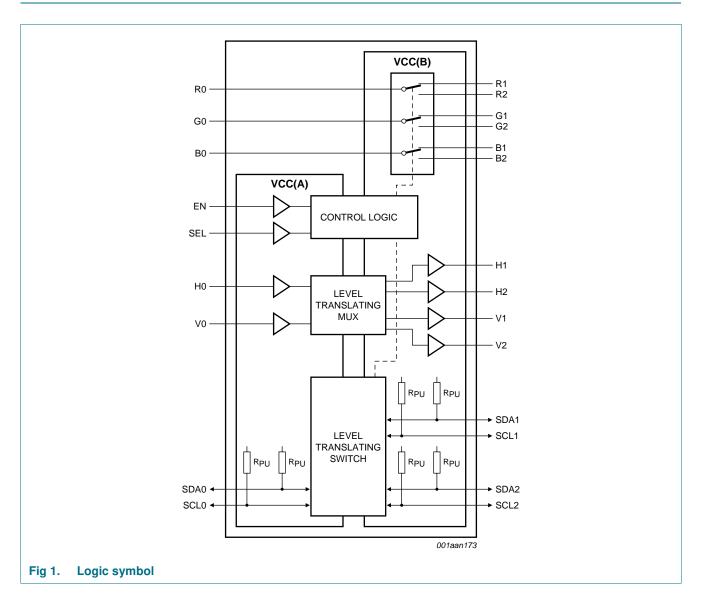
- Notebook Computers
- Docking stations
- Digital projectors
- Computer monitors
- Servers
- Storage



Ordering information 4.

Table 1. Ordering information						
Type number	Package					
	Temperature range	Name	Description	Version		
NX5DV715HF	–40 °C to +85 °C	HWQFN32	plastic thermal enhanced very very thin quad flat package; no leads; 32 terminals; body $3 \times 6 \times 0.75$ mm	SOT1180-1		

Functional diagram 5.



NX5DV715 Product data sheet

Dual supply 1-of-2 VGA switch

6. Pinning information

6.1 Pinning

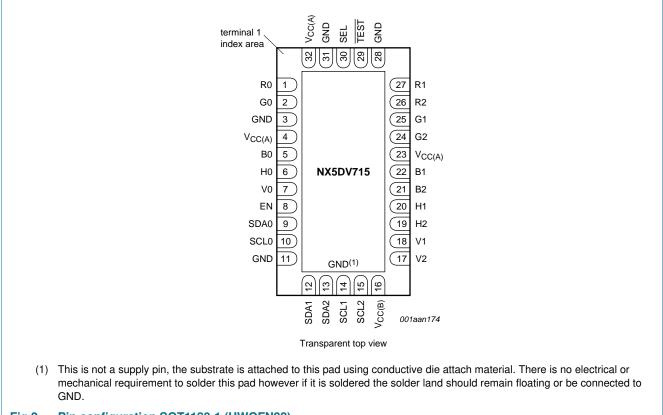


Fig 2. Pin configuration SOT1180-1 (HWQFN32)

6.2 Pin description

Table 2. **Pin description** Symbol Pin Description R0, G0, B0 1, 2, 5 RGB input or output GND 3, 11, 28, 31 ground (0 V) 4, 23, 32 supply voltage A V_{CC(A)} H0 6 horizontal sync input V0 7 vertical sync input ΕN 8 enable input (active HIGH) 9 SDA0 SDA0 input or output SCL0 10 SCL0 input or output SDA1, SDA2 12, 13 SDA input or output SCL1, SCL2 14, 15 SCL input or output 16 supply voltage B V_{CC(B)} V1, V2 18, 17 vertical sync output H1, H2 20, 19 horizontal sync output NX5DV715 All information provided in this document is subject to legal disclaimers © NXP B.V. 2011. All rights reserved.

Product data sheet

Fable 2. Pin descriptioncontinued				
Symbol	Pin	Description		
R1, G1, B1, R2, G2, B2	27, 25, 22, 26, 24, 21	RGB input or output		
TEST ^[1]	29	test pin (active LOW)		
SEL	30	select input		

[1] Test pin used to enable test mode. For normal usage, this pin must be connected to V_{CC(A)}.

7. Functional description

The NX5DV715 integrates high-bandwidth SPDT switches, level-translating buffers and level translating SPDT switches to provide a complete solution for 1-to-2 switching of VGA signals. An enable input (EN) is used to enable or disable the device and a select input (SEL) is used to determine which output is selected. When EN = LOW the device is disabled; all switches will be off, pull-up resistors will be disabled and H1, V1, H2, V2 will be forced LOW.

7.1 RGB switches

The NX5DV715 provides three identical single pole double throw high-bandwidth switches to route standard VGA RGB signals (see <u>Table 3</u>).

Table 3.Function table RGB

H = *HIGH* voltage level; *L* = *LOW* voltage level; *X* = *Don't* care.

Input		Switch
EN	SEL	
Н	L	R0 to R1; G0 to G1; B0 to B1
Н	Н	R0 to R2; G0 to G2; B0 to B2
L	Х	switches Rn, Gn, Bn off

7.2 H-Sync/V-Sync level translator

The horizontal and vertical synchronization buffers have inputs (H0, V0) referenced to $V_{CC(A)}$ and outputs (H1, V1 and H2, V2) that are referenced to $V_{CC(B)}$. This allows level translation of synchronization signals from as low as 2.0 V up to 5.5 V and supports low-voltage CMOS or TTL-compatible graphics controllers meeting the VESA specification for output drive of ± 8 mA. The EN input also controls the level shifter (See Table 4).

Table 4. Function table HV

H = HIGH voltage level; L = LOW voltage level; X = Don't care.

Input		Switch
EN	SEL	
Н	L	H1 = H0; V1 = V0; H2, V2 = L
Н	Н	H2 = H0; V2 = V0; H1, V1 = L
L	Х	L

7.3 Display-Data Channel Multiplexer

The NX5DV715 provides two identical SPDT active-level translating switches to route DDC signals (See <u>Table 5</u>). The switch outputs are limited to a diode drop less than the voltage applied on V_{CC(A)}. To provide VESA I²C-compatible signals 3.3 V should be applied to V_{CC(A)}. If voltage translation is not required V_{CC(A)} should be connected to V_{CC(B)}. Switch terminals include integrated pull-up resistors; inputs (SDA0, SCL0) are pulled up to V_{CC(A)}, outputs (SDA1, SCL1 and SDA2, SCL2) are pulled up to V_{CC(B)}. When the NX5DV715 is disabled (EN = LOW), the pull-up resistors are also disabled.

Table 5.Function table DDC

H = HIGH voltage level; L = LOW voltage level; X = Don't care.

Input		Switch
EN	SEL	
Н	L	SDA0 to SDA1, SCL0 to SCL1
Н	Н	SDA0 to SDA2, SCL0 to SCL2
L	Х	switches SDAn, SCLn off

8. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

					,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC(A)}	supply voltage A		-0.5	+6	V
V _{CC(B)}	supply voltage B		-0.5	+6	V
VI	input voltage		<u>[1]</u> –0.5	+6	V
V _{SW}	switch voltage		<u>[1]</u> –0.5	+6	V
I _{IK}	input clamping current	$V_{I} < -0.5 V$	-50	-	mA
I _{SK}	switch clamping current	$V_{I} < -0.5 V$	-50	-	mA
I _{OK}	output clamping current	$V_{O} < 0 V$	-50	-	mA
lo	output current	$V_{O} = 0 V$ to $V_{CC(B)}$	-	±50	mA
I _{CC}	supply current	I _{CC(A)} or I _{CC(B)}	-	100	mA
I _{GND}	ground current		-100	-	mA
I _{SW}	switch current	$V_{SW} > -0.5$ V or $V_{SW} < 6$ V; source or sink current	-	±30	mA
		V_{SW} > -0.5 V or V_{SW} < 6 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current	-	±90	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +85 \ ^{\circ}C$	[2] _	250	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] For HWQFN32 package: above 137 °C the value of P_{tot} derates linearly with 20.5 mW/K.

9. Recommended operating conditions

Recommended operating conditions					
Parameter	Conditions	Min	Тур	Max	Unit
supply voltage A		2	3.3	5.5	V
supply voltage B		4.5	5.0	5.5	V
ambient temperature	operating in free-air	-40	+25	+85	°C
input transition rise and fall rate	$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$	<u>[1]</u> -	20	-	ns/V
	$V_{CC(A)} = 3 V \text{ to } 3.6 V$	<u>[1]</u> -	10	-	ns/V
	$V_{CC(A)} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	<u>[1]</u> -	5	-	ns/V
	Parameter supply voltage A supply voltage B ambient temperature	$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	$\begin{tabular}{ c c c c } \hline Parameter & Conditions & Min \\ \hline supply voltage A & 2 \\ \hline supply voltage B & 4.5 \\ \hline ambient temperature & operating in free-air & -40 \\ \hline input transition rise and fall rate & V_{CC(A)} = 2.3 \ V to 2.7 \ V & \ \hline 11 & - \\ \hline V_{CC(A)} = 3 \ V to 3.6 \ V & \ \hline 11 & - \\ \hline \end{tabular}$	$\begin{array}{ c c c } \hline Parameter & Conditions & Min & Typ \\ \hline supply voltage A & 2 & 3.3 \\ \hline supply voltage B & 4.5 & 5.0 \\ \hline ambient temperature & operating in free-air & -40 & +25 \\ \hline input transition rise and fall rate & V_{CC(A)} = 2.3 V to 2.7 V & 11 & - & 20 \\ \hline V_{CC(A)} = 3 V to 3.6 V & 11 & - & 10 \\ \hline \end{array}$	ParameterConditionsMinTypMaxsupply voltage A2 3.3 5.5 supply voltage B 4.5 5.0 5.5 ambient temperatureoperating in free-air -40 $+25$ $+85$ input transition rise and fall rate $V_{CC(A)} = 2.3 V \text{ to } 2.7 V$ 11 $ 20$ $ V_{CC(A)} = 3 V \text{ to } 3.6 V$ 11 $ 10$ $-$

[1] Applies to control signal levels.

10. Static characteristics

Table 8. Static characteristics

V_{CC(B)} = 4.5 V to 5.5 V; V_{CC(A)} = 2 V to 5.5 V, unless otherwise specified; Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	T _{amb}	= -40 °C to	+85 °C	Unit
			Min	Typ[1]	Max	
General			ľ			
I _{CC(A)}	supply current A	$\label{eq:VCC(A)} \begin{array}{l} V_{CC(A)} = 3.3 \text{ V}; \text{ EN} = V_{CC(A)} \text{ or GND}; \\ \text{for H1, H2, V1, V2: } I_O = 0 \text{ A}; \\ \text{SCLn, SDAn unconnected} \end{array}$	-	-	2.0	μA
I _{CC(B)}	supply current B	$\label{eq:VCC(B)} \begin{split} V_{CC(B)} &= 5.0 \text{ V}; \text{ EN } = V_{CC(A)} \text{ or GND}; \\ \text{for H1, H2, V1, V2: } I_O &= 0 \text{ A}; \\ \text{SCLn, SDAn unconnected} \end{split}$	-	-	2.0	μA
HV buffe	er					
V _{IH}	HIGH-level input voltage	$V_{CC(A)} = 3 V \text{ to } 3.6 V$	2	-	-	V
V _{IL}	LOW-level input voltage	$V_{CC(A)} = 3 V \text{ to } 3.6 V$	-	-	0.8	V
V _H	hysteresis voltage		-	50	-	mV
l _l	input leakage current	$\label{eq:VCC} \begin{split} V_{CC(B)} &= V_{CC(A)} = 5.5 \text{ V}; \\ V_I &= GND \text{ to } V_{CC(A)} \end{split}$	-	-	±1	μA
V _{OH}	HIGH-level output voltage	$I_{O} = -8 \text{ mA}$	V _{CC(B)} 0.5		-	V
V _{OL}	LOW-level output voltage	I _O = 8 mA	-	-	0.5	V
I _{OFF}	power-off leakage current		-	-	±1	μA
RGB swi	itches					
$I_{S(OFF)}$	OFF-state leakage current	$ \begin{array}{l} V_{CC(B)} = 5.5 \text{ V}; \text{V}_{1} = 0.3 \text{ V or } 5.5 \text{ V}; \\ \text{V}_{O} = 0 \text{ V to } \text{V}_{CC(B)}; \text{ EN} = \text{V}_{CC(A)} \text{ or } \text{GND}; \\ \text{See } \underline{\text{Figure } 3} \end{array} $	-	-	±1	μA
I _{S(ON)}	ON-state leakage current		-	-	±1	μA
R _{ON}	ON resistance	$V_I = 0.7 \text{ V}; I_{SW} = -10 \text{ mA}; \text{See } \frac{\text{Figure 5}}{\text{Figure 6}}$ and $\frac{\text{Figure 6}}{\text{Figure 6}}$	[4] _	4	-	Ω

Dual supply 1-of-2 VGA switch

Symbol	Parameter	Conditions	Conditions		–40 °C t	o +85 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	
ΔR_{ON}	ON resistance mismatch between channels	$V_I = GND$ to 0.7 V; $I_{SW} = -10$ mA	[2]	-	0.5	-	Ω
R _{ON(flat)}	ON resistance (flatness)	V_{I} = GND to 0.7 V; I_{SW} = $-10\mbox{ mA}$	[3]	-	0.5	-	Ω
C _{S(OFF)}	OFF-state capacitance			-	4.5	-	pF
C _{S(ON)}	ON-state capacitance			-	12	-	pF
SDAn, S	CLn						
I _{S(OFF)}	OFF-state leakage current	$ \begin{array}{l} V_{CC(B)} = 5.5 \text{ V}; \ V_{CC(A)} = 3.6 \text{ V}; \ SCL0, \\ \text{SDA0, SCL1, SCL2, SDA1, SDA2} = \\ V_{CC(A)} \text{ or GND}; \ V_O = 0 \text{ V to } V_{CC(B)}; \\ \text{EN} = \text{GND}; \ \text{See} \ \underline{\text{Figure 3}} \end{array} $	[5]	-	-	±1	μA
R _{ON}	ON resistance	$\label{eq:VCC(A)} \begin{array}{l} V_{CC(A)} = 2 \ V; \ V_I = 0.4 \ V; \ I_{SW} = \pm 2 \ mA; \\ See \ \underline{Figure \ 5} \ and \ \underline{Figure \ 7} \end{array}$		-	9	-	Ω
C _{S(ON)}	ON-state capacitance			-	15	-	pF
R _{PU}	pull-up resistance			-	4.7	-	kΩ
Control L	ogic (SEL, EN)						
V _{IH}	HIGH-level input voltage	$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$		1.7	-		V
		$V_{CC(A)} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		2.0	-		V
		$V_{CC(A)} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$		$0.7V_{CC(A)}$	-		V
V _{IL}	LOW-level input voltage	$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$		-	-	0.7	V
		$V_{CC(A)} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	-	0.8	V
		$V_{CC(A)} = 4.5 \text{ V}$ to 5.5 V		-	-	$0.3V_{CC(A)}$	V
V _H	hysteresis voltage			-	50	-	mV
l _l	input leakage current	$V_{CC(A)} = 5.5 \text{ V}; \text{ V}_{I} = \text{GND to } V_{CC(A)}$		-	-	±1	μA

Table 8. Static characteristics ... continued Vacuum 4.5 V to 5.5 V Vacuum 2.2 V to 5.5 V

place otherwise encotified: Valtages are referenced to CND (around = 0.1/)

[1] All typical values are measured at $V_{CC(B)} = 5$ V, $V_{CC(A)} = 3.3$ V and $T_{amb} = 25$ °C unless otherwise specified.

[2] Measured at identical V_{CC}, temperature and input voltage.

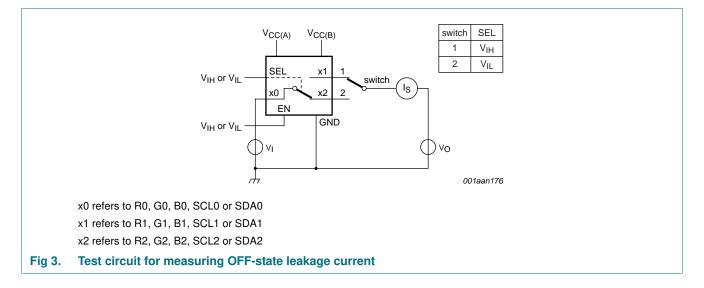
Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and [3] temperature.

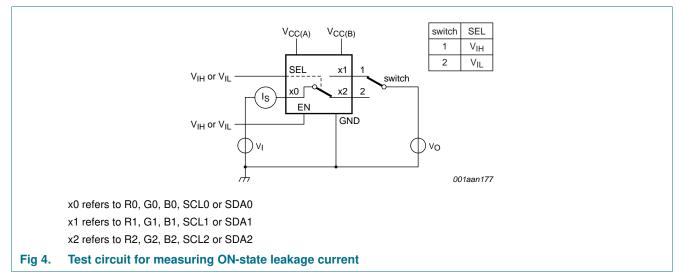
Guarantees the LOW level. [4]

Guarantees the HIGH level. [5]

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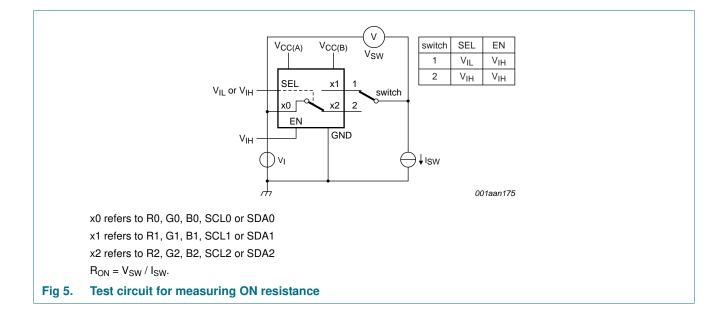
10.1 Test circuits and waveforms

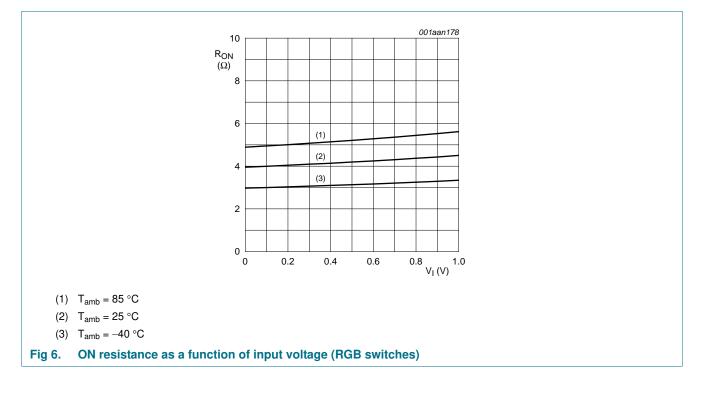






Dual supply 1-of-2 VGA switch

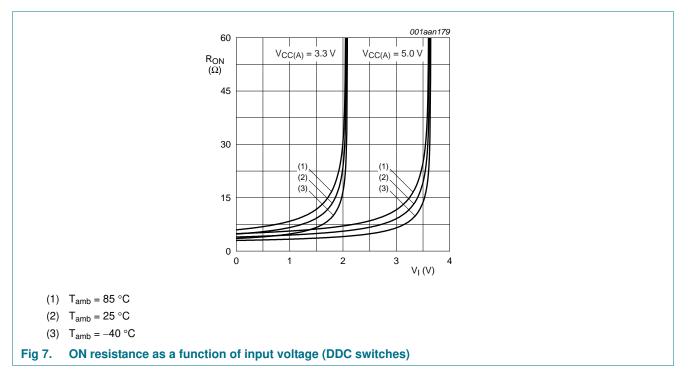




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11. Dynamic characteristics

Table 9.Dynamic characteristics

At recommended operating conditions; Voltages are referenced to GND (ground = 0 V; $V_{CC(B)}$ = 4.5 V to 5.5 V; $V_{CC(A)}$ = 2 V to 5.5 V.

Symbol	mbol Parameter Conditions			T _{amb} =	T _{amb} = −40 °C to +85 °C		
				Min	Typ <mark>[1]</mark>	Max	
t _{pd}	propagation delay	H0 to H1, H2 and V0 to V1, V2; See <u>Figure 8</u> and <u>Figure 9</u>	[2]	-	3	-	ns
t _{en}	enable time	EN and SEL to all other outputs; See <u>Figure 10</u> and <u>Figure 11</u>		-	15	-	ns
t _{dis}	disable time	EN and SEL to all other outputs; See <u>Figure 10</u> and <u>Figure 11</u>		-	5	-	ns
t _{b-m}	break-before-make time	See Figure 12		-	10	-	ns
t _{sk(o)}	output skew time	Skew between any Rn, Gn and Bn ports; see <u>Figure 8</u>	<u>[3]</u>	-	50	-	ps

[1] All typical values are measured at $V_{CC(B)} = 5 \text{ V}$; $V_{CC(A)} = 3.3 \text{ V}$; $T_{amb} = 25 \text{ °C}$.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] Guaranteed by design.

Dual supply 1-of-2 VGA switch



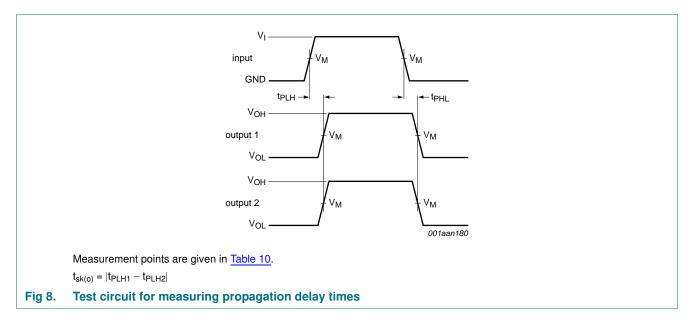


Table 10. Measurement points

Input		Output		
V _M	VI	V _X	V _M	
0.5V _{CC(A)}	GND to V _{CC(A)}	0.9V _{OH}	0.5V _{CC(B)}	

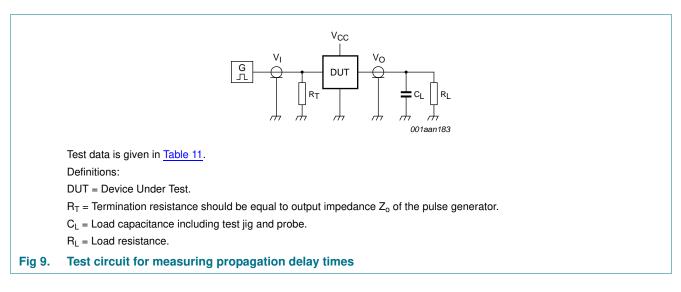
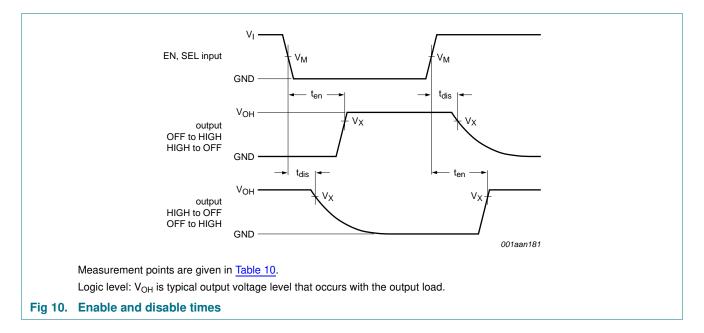


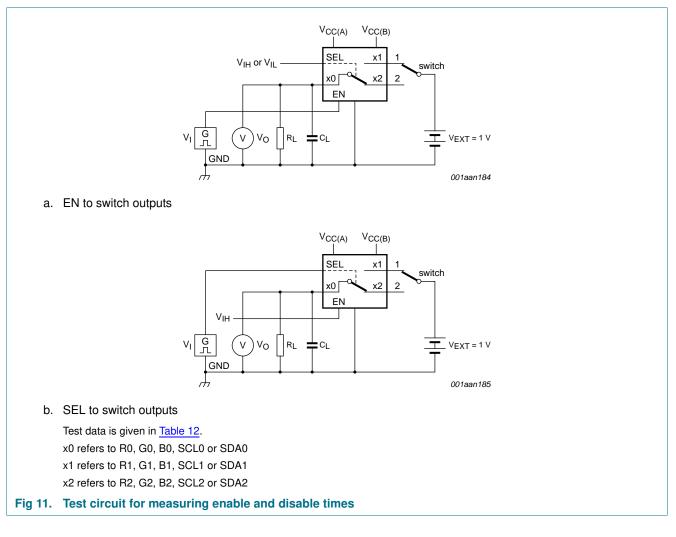
Table 11. Test data

Input	Load		
t _r , t _f	CL	RL	
≤ 2.5 ns	10 pF	1 kΩ	

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nput		Load		
r, t _f	VI	CL	RL	
≤ 2.5 ns	GND to $V_{CC(A)}$	10 pF	100 Ω	
		$V_{CC(A)} \qquad V_{CC(B)}$ $SEL \qquad x1$ $x0 \qquad x2$ EN $R_L = C_L$	VEXT = 1 V 001aan182	
a. Test circuit				
	V1 0.	5VI		
	vo	0.9Vo	0.9V ₀ 001aag572	
b. Input and output m	easurement points			
Test data is given in x0 refers to R0, G0, I	T <u>able 12</u> . 30, SCL0 or SDA0			
x1 refers to R1, G1, I				
x2 refers to R2, G2, I	B2, SUL2 of SDA2	-make timing		

NX5DV715 Product data sheet

12. Additional dynamic characteristics

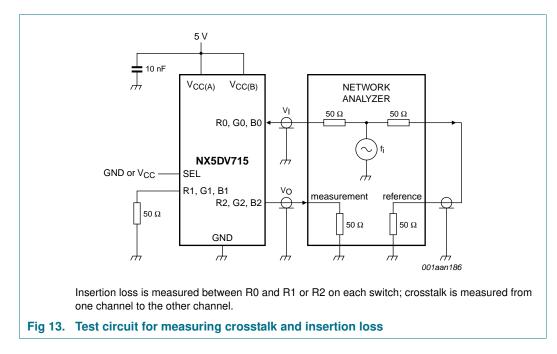
Table 13. Additional dynamic characteristics

 $V_{CC(B)}$ = 5.0 V ± 10 %, $V_{CC(A)}$ = 2 V to 5.5 V, unless otherwise specified; Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions		T _{amb} =	T_{amb} = -40 °C to +85 °C		Unit
			Ī	Min	Тур	Max	
$f_{(-3dB)}$	-3 dB frequency response	$R_L = 50 \Omega$; see Figure 13	[1]	-	600	-	MHz
α_{ins}	Insertion loss	f _i = 1 MHz; R _L = R _S = 50 Ω; see <u>Figure 13</u>		-	0.6	-	dB
Xtalk	crosstalk	between switches; $f_i = 50 \text{ MHz}$; R _L = 50 Ω ; see Figure 13	[1]	-	-50	-	dB

[1] f_i is biased at 0.5V_{CC}.

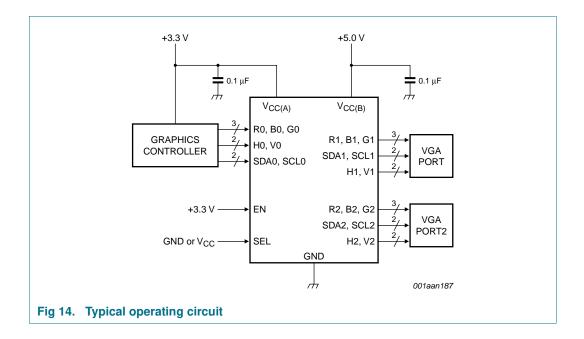
12.1 Test circuits



Dual supply 1-of-2 VGA switch

13. Application information

The NX5DV715 provides the level shifting necessary to drive two standard VGA ports from a graphic controller as low as 2.2 V. Internal buffers drive the H-Sync and V-Sync signals to VGA standard TTL levels. The DDC multiplexer provides level shifting by clamping signals to a diode drop less than $V_{CC(A)}$ (See Figure 14). Connect $V_{CC(A)}$ to 3.3 V for normal operation, or to $V_{CC(B)}$ to disable voltage clamping for DDC signals



Dual supply 1-of-2 VGA switch

14. Package outline

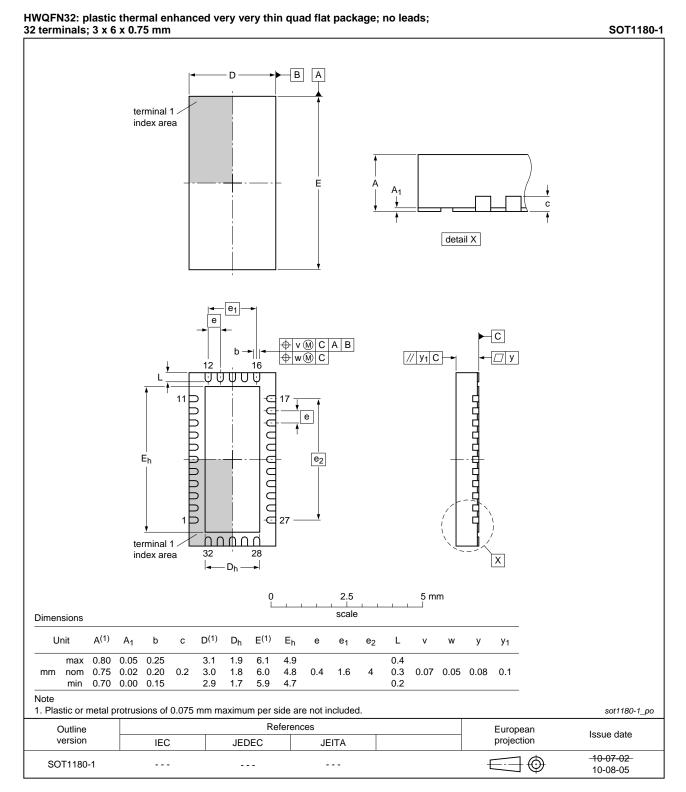


Fig 15. Package outline SOT1180-1 (HWQFN32)

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NX5DV715

Dual supply 1-of-2 VGA switch

15. Abbreviations

Table 14.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DDC	Display Data Channel
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
RGB	Red Green Blue
TTL	Transistor-Transistor Logic
VESA	Video Electronics Standards Association

16. Revision history

Document IDRelease dateData sheet statusChange noticeSupersedesNX5DV715 v.320111104Product data sheet-NX5DV715 v.2Modifications:• Legal pages updated-VX5DV715 v.2NX5DV715 v.220110725Product data sheet-NX5DV715 v.1	Table 15. Revisio	n history			
Modifications: • Legal pages updated	Document ID	Release date	Data sheet status	Change notice	Supersedes
	NX5DV715 v.3	20111104	Product data sheet	-	NX5DV715 v.2
NX5DV715 v.2 20110725 Product data sheet - NX5DV715 v.1	Modifications:	 Legal pages 	s updated		
	NX5DV715 v.2	20110725	Product data sheet	-	NX5DV715 v.1
NX5DV715 v.1 20101220 Product data sheet	NX5DV715 v.1	20101220	Product data sheet	-	-

17. Legal information

17.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Dual supply 1-of-2 VGA switch

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